Technical Specifications

HP ProBook 455 G7 Notebook PC



Left

- 1. Internal Microphones (2)
- 2. Webcam
- 3. Privacy Shutter (Only available with webcam)
- 4. Webcam LED
- 5. Clickpad
- 6. Hard Drive LED

- 7. SD Card Reader
- 8. Thermal Vent
- 9. USB 2.0 Port
- 10. Standard Security Lock Slot (Lock sold separately)
- 11. Power Button



Technical Specifications



Right

- 1. Power Connector
- 2. USB Type-C® 3.1 Gen 2 Port
- 3. Ethernet Port (RJ-45)
- 4. HDMI Port (Cable not included)

- 5. USB 3.1 Gen 1 Port
- 6. USB 3.1 Gen 1 Port
- 7. Headphone / Microphone Combo Jack
- 8. Fingerprint Sensor (select models)



Technical Specifications

At a Glance

- Preinstalled Windows 10 versions or FreeDOS
- Choice of AMD Ryzen™ 4000 series mobile processors, R7, R5 and R3
- Display include your choice of 39.62 cm (15.6") diagonal HD, Ultra Wide Viewing Angle FHD, And Privacy Panel option
- Enhanced security features including TPM2.0, HP Sure Sense, HP Sure Start, HP BIOSphere, Hardware enforced Firmware Protection, optional Fingerprint sensor (select models)⁴, optional IR camera, and optional Privacy Panel
- Designed to pass 19 MIL-STD 810H testing¹
- Weight starting at 4.41 lb (2.0kg) (Weight will vary by configuration)
- HP Long-Life Rechargeable battery, with HP Fast Charge Technology recharges 50% in 30 minutes²
- Up to 512 GB Solid State Drives and 1 TB Hard Drive
- Up to 32 GB total system memory
- 720p HD webcam, IR camera for face authentication with Windows Hello
- Spill-resistent and optional backlit Keyboard³, and Clickpad with multi-touch gestures enabled, taps enabled as default
- 1. MIL-STD-810H testing is not intended to demonstrate fitness of U.S. Department of Defense (DoD) contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.
- 2. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.
- 3. Backlit keyboard is an optional feature that must be configured at purchase
- 4. HP Fingerprint Sensor is an optional feature and requires configuration at purchase.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAME

HP ProBook 455 G7 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 10 Pro 64¹

Windows 10 Pro 64 (National Academic only)2

Windows 10 Home 64¹

Windows 10 Home Single Language 64¹ Windows® 10 Enterprise 64 (Web Support)¹

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

PROCESSORS

AMD Ryzen™ 3 4300U APU with Renoir™ Vega 6 Graphics (2.7 GHz base clock, up to 3.7 GHz max boost clock, 4 MB L3 cache, four-cores)^{3,4,5,6}

AMD Ryzen™ 5 4500U APU with Renoir™ Vega 8 Graphics (2.3 GHz base clock, up to 4.0 GHz max boost clock, 4 MB L3 cache, six-cores)^{3,4,5,6}

AMD Ryzen™ 7 4700U APU with Renoir™ Vega 10 Graphics (2.0 GHz base clock, up to 4.1 GHz max boost clock, 4 MB L3 cache, eight-cores)^{3,4,5,6}

AMD Ryzen™ 5 PRO 4650U APU with Radeon™ Graphics (2.1 GHz base clock, up to 4 GHz max boost clock, 8 MB L3 cache, 6 cores)^{3,4,5}

AMD Ryzen™ 7 PRO 4750U APU with Radeon™ Graphics (1.7 GHz base clock, up to 4.1 GHz max boost clock, 8 MB L3 cache, 8 cores)^{3,4,5}

Processors Family

AMD Ryzen™ 4000 Series Mobile processors6

- 3. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 4. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 5. AMD Max Burst frequency performance varies depending on hardware, software and overall system configuration.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



Technical Specifications

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon™ Graphics7

Note: View processor section for details.

Supports

Support HD decode, DX12, HDMI 1.4

7. HD content required to view HD images.

DISPLAY

Internal

Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED backlit slim, 220 cd/m², 45% NTSC (1366 x 768)^{7,8}
39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED backlit slim, 220 cd/m², 45% NTSC for HD camera (1366 x 768)^{7,8}
39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED backlit slim, 220 cd/m², 45% NTSC for HD + IR camera (1366 x 768)^{7,8}
39.6 cm (15.6") diagonal FHD IPS eDP anti-glare LED-backlit slim, 250 cd/m², 45% NTSC (1920 x 1080)^{7,8}
39.6 cm (15.6") diagonal FHD IPS eDP anti-glare LED-backlit slim, 250 cd/m², 45% NTSC for HD camera (1920 x 1080)^{7,8}
39.6 cm (15.6") diagonal FHD IPS eDP anti-glare LED-backlit slim, 250 cd/m², 45% NTSC for HD + IR camera (1920 x 1080)^{7,8}
39.6 cm (15.6") diagonal FHD eDP+PSR anti-glare LED-backlit flat, 1000 cd/m², 72% NTSC for HD Webcam Privacy (1920x1080)^{7,8}

Supports narrow bezel

HDMI

HDMI1.4b, up to 4K 30Hz

- 7. HD content required to view HD images.
- 8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.



Technical Specifications

Docking station model	Total number of supported displays (incl. the notebook display)	Max. resolutions supported	Dock Connectors	Technical limitations
HP Thunderbolt Dock 120W G2	3	Dual 4k @60Hz	2xDP, 1xVGA, 1xTB,1xUSB-C alt-mode	Dual 4k only with one display in to DP and + TB port or USB-C alt mode + TB port
HP USB-C Dock G4	3	Dual 2K @ 60Hz Single 4K @ 60Hz (3840 x 1440)	1xHDMI, 2xDP	
HP USB-C Universal Dock	3	Dual 4K @ 60Hz Single 5K @ 60Hz	2xDP	
HP USB-C Travel Dock	2	Single 2K @ 60Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time
HP USB-C Mini Dock	2	Single 4K @ 30Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time
HP USB-C/A Universal Dock G2	3	Dual 2.5K @ 60Hz	2xDP, 1xHDMI	
HP USB-C Dock G5	3	Dual 2.5K @ 60Hz or 4K @ 60Hz + FHD @ 60Hz	2xDP, 1xHDMI	



Technical Specifications

STORAGE AND DRIVES

Primary Storage

500 GB 7200 rpm SATA⁹ 1 TB 5400 rpm SATA⁹

Primary M.2 Storage

128 GB SATA TLC Solid State Drive⁹
256 GB PCIe[®] NVMe[™] Value Solid State Drive⁹
512 GB PCIe[®] NVMe[™] TLC Solid State Drive⁹
512 GB PCIe[®] NVMe[™] Value Solid State Drive⁹

9. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

MEMORY

Maximum Memory

32 GB DDR4-3200 SDRAM1611

Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB)¹¹
16 GB DDR4-3200 SDRAM (2 x 8 GB)¹¹
16 GB DDR4-3200 SDRAM (1 x 16 GB)¹¹
12 GB DDR4-3200 SDRAM (1 x 4 GB and 1 x 8 GB)¹¹
8 GB DDR4-3200 SDRAM (1 x 8 GB)¹¹
8 GB DDR4-3200 SDRAM (2 x 4 GB)¹¹
4 GB DDR4-3200 SDRAM (1 x 4 GB)¹¹

Memory Slots

2 SODIMM

Both slots are customer accessible / upgradeable by IT or self-maintainers only DDR4 PC4 SODIMMS, system runs at 3200

Supports Dual Channel Memory

10. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8822CE 802.11 a/b/g/n/ac (2x2) Wi-Fi® + Bluetooth® 5 Combo¹¹ Intel® Dual Band Wi-Fi® 6 AX200 802.11ax (2x2) and Bluetooth® 5 Combo, non-vPro™¹¹ Intel® Dual Band Wireless-AC 9260 802.11 a/b/g/n/ac (2x2) Wi-Fi® and Bluetooth® 5 Combo, non-vPro™¹¹

Ethernet

Realtek RTL8111EP 10/100/1000 NIC12

11. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported



Technical Specifications

12. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

Integrated microphone (Mono or Dual Array)
2 Integrated stereo speakers

Camera

720p HD camera⁷ 720p HD + IR camera^{7,13}

7. HD content required to view HD images.

13. IR camera is an optional feature that must be configured at purchase.

KEYBOARDS/POINTING DEICES/BUTTONS & FUNCTION KEYS

Kevboard

HP Premium Keyboard, spill resistant with numeric keypad and optional backlit14

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

F1 - Display Switching

F2 - Blank or SureView On/Off

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Blank

F11 - Wireless

F12 - Sleep

Hidden Functions

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

14. Backlit keyboard is an optional feature that must be configured at purchase.

SOFTWARE AND SECURITY

BIOS

HP BIOSphere Gen5¹⁵
HP Drive Lock & Automatic Drive Lock¹⁶



Technical Specifications

BIOS Update via Network Master Boot Record Security Power On Authentication Secure Erase¹⁷ Absolute Persistence Module¹⁸ Pre-boot Authentication

Software

HP Connection Optimizer
HP Image Assistant
HP Hotkey Support
HP JumpStarts
HP Support Assistant¹⁹
HP Noise Cancellation Software
Buy Office (sold separately)

Manageability Features

HP Driver Packs²⁰
HP System Software Manager (SSM)
HP BIOS Config Utility (BCU)
HP Client Catalog
HP Manageability Integration Kit Gen3²¹

Client Security Software

HP Client Security Manager Gen5²² Windows Defender²³ HP Fingerprint Sensor²⁴

Security Management

HP Sure Start Gen5²⁸

Pre-boot Authentication
TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)²⁵
USB enable/disable (via BIOS)
Power-on password (via BIOS)
Setup password (via BIOS)
Support for chassis padlocks and cable lock devices
HP Fingerprint Sensor²⁴
HP Sure Sense²⁶
HP Sure Click²⁷

15. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.

16. HP Drive Lock & Automatic Drive Lock is not supported on NVMe drives

17. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-

88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

18. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

19. HP Support Assistant requires Windows and Internet access.

20. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

21. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

22. HP Client Security Manager Gen5 requires Windows and is available on the select HP Pro and Elite PCs. See product specifications for details.



Technical Specifications

- 23. Windows Defender Opt in and internet connection required for updates.
- 24. HP Fingerprint Sensor is an optional feature and requires configuration at purchase.
- 25. Firmware TPM is version 2.0.

26. HP Sure Sense requires Windows 10. See product specifications for availability. On HP Elite x2 G4 units with WWAN shipping to China, HP Sure Sense is only available via Softpag download.

27. HP Sure Click is available on select HP platforms and supports Microsoft Internet Explorer, Google Chrome™, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

28. HP Sure Start Gen5 is available on select HP PCs with Intel processors. See product specifications for availability.

POWER

Power Supply

HP Smart 65 W External AC power adapter²⁹
HP Smart 65 W EM External AC power adapter²⁹
HP Smart 65 W USB Type-C[®] adapter²⁹
HP Smart 45 W External AC power adapter²⁹
HP Smart 45 W USB Type-C[®] adapter²⁹

Power Cord

3-wire plug - 1.8 m²⁹
3-wire plug - 1.0 m²⁹
2-wire plug - 1.0 m²⁹
Duckhead power cord - 1.0 m²⁹
Duckhead power cord - 1.8 m²⁹

Primary Battery

HP Long Life 3-cell, 45 Wh Li-ion polymer³⁰

Battery Life

14 hours³¹

Battery Weight

0.22 kg 0.49 lb

- 29. Availability may vary by country.
- 30. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 31. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details..



Technical Specifications

WEIGHTS & DIMENSIONS

Weight

Starting at 4.41 lb³² Starting at 2.0 kg³²

Dimensions (w x d x h)

14.37 x 10.11 x 0.75 in 36.49 x 25.69 x 1.89 cm

32. Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

Ports

1 USB 3.1 Type-C[®] Gen 2 (Power delivery, DisplayPort™ 1.2)

2 USB 3.1 Gen 1

1 USB 2.0 (powered port)

1 HDMI 1.4³³

1 RJ-45

1 AC power

1 stereo headphone/microphone combo jack

Expansion Slots

1SD

Supports SD, SDHC, SDXC

33. HDMI cable sold separately.



Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19V Average Operating Power 8.1 W

Integrated graphics Yes (AMD Radeon™ Graphics)

Max Operating Power Discrete < 65 W

UMA < 45 W

Temperature

Operating 32° to 95° F (0° to 35° C) (Not writing optical) Non-operating -4° to 140° F (-20° to 60° C) (Writing optical)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

Random Vibration

Operating 0.75 grms Non-operating 1.50 grms

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Yes

Planned Industry Standard

Certifications

UL Yes CSA Yes **FCC Compliance** Yes

Energy Star® Selected models35 **EPEAT® 2019** Yes. Gold in U.S.³⁶

ICES Yes Australia Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes



GOST

Technical Specifications

Saudi Arabian Compliance (ICCP) Yes SABS Yes

35. Configurations of the HP ProBook 455 G7 that are ENERGY STAR® qualified are identified as HP ProBook 455 G7 ENERGY STAR® on HP websites and on http://www.energystar.gov.

36. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 15.6 inch diagonal HD (1366 x 768) Anti-Glare WLED SVA 45% NTSC 220 nits eDP 1.2 w/o PSR slim NB non-touch

 Outline Dimensions (W x H x D)
 350.96 x 216.75 (max.)

 Active Area
 344.16 x 193.59 (typ.)

Weight <370g max.

Diagonal Size 15.6"

Thickness 3.2mm max.
Interface eDP 1.2
Surface Treatment Anti-glare
Touch Enabled No

i ouch Enabled No

Contrast Ratio 300:1 (typ)
Refresh Rate 60Hz

Brightness 220 nits typical (Panel Only)

Pixel Resolution 1366 x 768 (HD)

Format of LCD Pixel Arrangement RGB
Backlight LED

Color Gamut Coverage45% of NTSCColor Depth6 bits + Hi FRCViewing AngleSVA 40/40/15/30

Panel LCD 15.6 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45% NTSC 250 nits eDP 1.2 w/o PSR slim NWBZ

 Outline Dimensions (W x H x D)
 350.96 x 216.65 mm (max)

 Active Area
 344.16 x 193.59 mm (typ.)

Weight 370 g (max)

Diagonal Size 15.6 inch

Thickness 3.2 mm (max)

Interface eDP 1.2 (2 lane)

Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio 600:1 (typ.)
Refresh Rate 60 Hz



Technical Specifications

Brightness 250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB Backlight LED

Color Gamut Coverage 45% of NTSC

Color Depth 6 bits

Viewing Angle UWVA 85/85/85

Panel LCD 15.6 inch Outline Dim diagonal FHD (1920 x 1080) Active Area Anti-Glare WLED UWVA 72% Weight NTSC 1000 nits eDP 1.4+PSR2 flat Privacy Diagonal Si:

 Outline Dimensions (W x H x D)
 349.52 x 204.79 mm (max)

 Active Area
 344.16 x 193.59 mm (typ.)

 Weight
 350 g (max)

 Diagonal Size
 15.6 inch

 Thickness
 2.6 mm (max)

Interface eDP 1.4 + PSR2 (4 lane)

Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio2000:1 (typ.)Refresh Rate60 HzBrightness1000 nits

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB Backlight LED

Color Gamut Coverage 72% of NTSC

Color Depth 8 bits

Viewing Angle UWVA 85/85/85



Technical Specifications

STORAGE AND DRIVES

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software

500 GB 7200 rpm SATA Hard Drive **Drive Weight** 0.20 lbs (92 g) ~ 0.21 lbs (95 g)

Rotation speed7200 rpmCache BufferUp to 32 MBHeight0.28 in (7 mm)Width2.75 in (69.85 mm)InterfaceATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms Average: 11 ~ 13 ms

Maximum: 18 ~ 22 ms

Logical Blocks 976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

1 TB 5400 rpm SATA Hard Drive

Drive Weight0.21 lbs (94 g)Rotation speed5400 rpmCache BufferUp to 32 MBHeight0.28 in (7.2 mm)Width2.75 in (69.85 mm)InterfaceATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ms Average: 12 ~ 13 ms

Maximum: 18 ~ 22 ms

Logical Blocks 1,953,525,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA



Technical Specifications

SSD 128 GB 2280 M2 SATA-3 TLC

Form Factor M.2 2280
Capacity 128 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 ATA-8, SATA 3.0

 Maximum Sequential Read
 Up To 520 MB/s

 Maximum Sequential Write
 Up To 450 MB/s

 Logical Blocks
 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

256 GB 2280 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp To 1700 MB/sMaximum Sequential WriteUp To 1300 MB/sLogical Blocks500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

512 GB 2280 M2 PCIe NVMe Form Factor TLC Solid State Drive Capacity

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X4Maximum Sequential ReadUp To 2600 MB/sMaximum Sequential WriteUp To 1400 MB/sLogical Blocks1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2



Technical Specifications

512 GB 2280 PCIe NVMe Value Solid State Drive

Form Factor M.2 2280
Capacity 512 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 Up To 1500 ~ 1700 MB/s

 Maximum Sequential Write
 Up To 860 ~ 1500 MB/s

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security, TRIM; L1.2



Technical Specifications

NETWORKING/COMMUNICATIONS

Intel® Wi-Fi 61 AX200 and Wireless LAN Standards IEEE 802.11a IEEE 802.11b Bluetooth® 5.0 802.11ax IEEE 802.11q (2x2). non-vPro. IEEE 802.11n supporting gigabit file IEEE 802.11ac transfer speeds IEEE 802.11ax non-vPro IEEE 802.11d IEEE 802.11e

IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability Wi-Fi CERTIFIED™ **Frequency Band** •802.11b/g/n/ax

> 2.402 - 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

> • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security³ • IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

WAPI

Network Architecture

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

Roaming Output Power² IEEE 802.11 compliant roaming between access points

• 802.11b: +18.5dBm minimum

 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

• 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum • 802.11n HT20(5GHz): +15.5dBm minimum



Technical Specifications

802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum
802.11ax HT40(2.4GHz): +10dBm minimum
802.11ax VHT160(5GHz): +10dBm minimum

Power Consumption • Transmit mode 2.0 W

• Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode 50 mW (WLAN unassociated)

Connected Standby 10 mW
 Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum
802.11ac, MCS0: -84dBm maximum
802.11ac, MCS9: -59dBm maximum

802.11ax, MCS11(HT40): -59dBm maximum
802.11ax, MCS11(VHT160): -58.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

Temperature Operating Operating: 14° to 158° F (-10° to 70° C)

Non-operating Non-operating: -40° to 176° F (-40° to 80° C)

Humidity Operating Operating: 10% to 90% (non-condensing)

Non-operating Non-operating: 5% to 95% (non-condensing)

Altitude Operating: 0 to 10,000 ft (3,048 m)

Non-operating Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED OFF – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth® Specification 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate⁴ Legacy: 3 Mbps Signaling Data Rate 2.17 Mbps



Technical Specifications

BLE: 1 Mbps Signaling Data Rate 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Bluetooth Software

Supported Link Topology Microsoft Windows Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 —Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of

transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Technical Specifications

Intel® 802.11a/b/g/n/ac Wireless LAN Standards IEEE (2x2) Wi-Fi® and IEEE

Bluetooth® 5.0 Combo¹

Non-vPro

IEEE 802.11a IEEE 802.11b

IEEE 802.11a

IEEE 802.11n

IEEE 802.11ac

IEEE 802.11d

IEEE 802.11e IEEE 802.11h

IEEE 802.11i

IEEE 802.11k

IEEE 802.11r

IEEE 802.11v

Interoperability Wi-Fi CERTIFIED™

Frequency Band •802.11b/g/n

2.402 – 2.482 GHz

•802.11a/n/ac

4.9 - 4.95 GHz (Japan)

5.15 – 5.25 GHz

5.25 – 5.35 GHz 5.47 – 5.725 GHz

5.825 - 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

•802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³ •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

•IEEE 802.11i

•WAPI

Network Architecture

Output Power²

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

• 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum

• 802.11a: +18.5dBm minimum

• 802.11n HT20(2.4GHz): +15.5dBm minimum

802.11n HT40(2.4GHz): +14.5dBm minimum
 802.11n HT20(5GHz): +15.5dBm minimum

• 802.11n HT40(5GHz): +14.5dBm minimum

• 802.11ac VHT80(5GHz): +11.5dBm minimum

• 802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption • Transmit mode 2.0 W

•Receive mode 1.6 W

•Idle mode (PSP) 180 mW (WLAN Associated)

•Idle mode 50 mW (WLAN unassociated)

•Connected Standby/Modern Standby: 10mW

•Radio disabled 8 mW



Technical Specifications

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna.

One embedded dual band 2.4/5 GHz antenna is provided to the card to

support WLAN communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Type 1216: 1.67 x 12.0 x 16.0 mm

Weight Type 2230: 2.8 g

Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

Temperature Operating: 14° to 158° F (–10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

Humidity Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Altitude Operating: 0 to 10,000 ft (3,048 m)

Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

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Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Electrical Interface USB 2.0 compliant

Bluetooth Software Micros

Supported Link Topology Microsoft Windows Bluetooth Software



Technical Specifications

Power Management Microsoft Windows ACPI, and USB Bus Support Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management ETS 300 328, ETS 300 826 Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

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802.11a/b/g/n/ac (2x2) Wireless LAN Standards Wi-Fi® and Bluetooth®

5.0

IEEE 802.11a IEEE 802.11b IEEE 802.11q IEEE 802.11n

IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Wi-Fi CERTIFIED™ Interoperability **Frequency Band** •802.11b/q/n

2.402 - 2.482 GHz •802.11a/n/ac

4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz

5.25 - 5.35 GHz 5.47 - 5.725 GHz



Technical Specifications

5.825 - 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz & 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³ •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

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•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification •IEEE 802.11i •WAPI

Network Architecture

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Infrastructure (Access Point Required)

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Output Power²

IEEE 802.11 compliant roaming between access points

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802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption

•Transmit mode: 2.0 W •Receive mode: 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

•Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴

802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Type 1216: 1.67 x 12.0 x 16.0 mm

Weight Type 2230: 2.8 g

Type 126: 1.3 g



Technical Specifications

Operating Voltage 3.3v +/- 9%

Operating: 14° to 158° F (-10° to 70° C) **Temperature**

Non-operating: -40° to 176° F (-40° to 80° C)

Humidity Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Operating: 0 to 10.000 ft (3.048 m) **Altitude**

Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF

LED OFF - Radio ON

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channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Bluetooth Software

Supported **Link Topology** Microsoft Windows Bluetooth Software

Power Management

Microsoft Windows ACPI, and USB Bus Support Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping

LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP)



Technical Specifications

Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited.
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- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTK8111HSH
10/100/1000 Integrated
NIC

Connector RJ-45
System Interface PCIe + SMBus

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-

30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

Power Management ACPI compliant – multiple power modes

Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power

consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling Jumbo Frame 9K

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30)

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Management Interface Auto MDI/MDIX Crossover cable detection



Technical Specifications

POWER

HP 45 W Smart AC adapter **Dimensions (H x W x D)** 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)

Weight 0.386 lb (175 g) max

Not including power cord. Power cord varies by country

Input 90 to 265 VAC

Input Efficiency 87.74% at 115 VAC and 88.4% at 230

VAC

Input frequency range 47 to 63 Hz
Input AC current 1.4 A at 90 VAC

Output Output power 45 W

DC output 19.5 V

Hold-up time 5 msec at 115 VAC input

Output current limit <8.0 A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating

temperature

32° to 95° F (0° to 35° C)

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity20% to 95%Storage Humidity10% to 95%

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65 W Smart AC adapter

 Dimensions
 90 x 51 x 28.5 mm

 Weight
 220 g +/- 10 g

Not including power cord. Power cord varies by country

Input Input Efficiency 88% min at 115 VAC and 89.0% at 230 VAC

Input frequency range 47 to 63 Hz

Input AC current Max. 1.7 A at 90 VAC

Output Output power 65 W

DC output 19.5 V

Hold-up time 5 msec at 115 VAC input

Output current limit <11.0 A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature



Technical Specifications

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65 W EM Smart AC adapter **Dimensions** 102 x 55 x 30 mm

Weight 270g +/- 10g

Not including power cord. Power cord varies by country

Input Efficiency 87% min at 115V/230V

Input frequency range 47 to 63 Hz

Input AC current 1.7 A at 90 Vac and maximum load

DC output 65 W (19.5V/3.33A) **Hold-up time** 5 msec at 115 VAC input

Output current limit <11 A, Over voltage protection- 29V max

automatic shutdown

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 5,000 m Humidity 0% to 95% Storage Humidity 0% to 95%

EMI and Safety Certifications *CE Mark - EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability - failure rate of less than 0.1% annually within the first three years of operation.

*MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Dimensions USB Type-C®

 Dimensions
 74 x 74 x 28.5 mm

 Weight
 245 q +/- 10 q

Not including power cord. Power cord varies by country

Input Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A

89% min at 115 Vac/ 230Vac @ 20V/3.25A



Technical Specifications

Input frequency range 47 to 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

Output power 65 W

DC output 5V/9V/10V/12V/15V/20V **Hold-up time** 5ms at 115 VAC input

Output current limit <8.0A

Connector USB Type-C®

Environmental Design Operating 32° F to 95° F (0° to 35° C)

temperature

Non-operating (storage) -4° F to 185° F (-20° to 85° C)

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Altitude 0 to 16,400 ft (0 to 5000m)

Humidity5% to 95%Storage Humidity5% to 95%

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FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt nPFC Dimensions USB Type-C®

Dimensions 94.0mm x 40.0mm x 26.5mm

Weight 192.5q +/-10%

Not including power cord. Power cord varies by country

Input Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:87.41% 15V:87.8%

Input frequency range 47 to 63 Hz

Input AC current Max. 1.4 A at 90 VAC

Output power 5V/15W

9V/27W 12V/36W 15V/45W

DC output 5V/9V/12V/15V **Hold-up time** 5ms at 115 VAC input

inota aptimic sinsat its vitempa

Output current limit <5.0 A

Connector USB Type-C®

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature



Technical Specifications

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

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3 Cell WHr 45 Long Life -Polymer HP Fast Charge Technology¹ **Dimensions (H x W x L)** 6.0 x 184.7 x 88.9 mm

Weight 0.22 kg (0.48 lb)
Cells/Type 3cell Lithium-Ion

Voltage 11.55 V
Amp-hour capacity 3.900 Ah
Watt-hour capacity 45 Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

No



^{1.} Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP 17.3 Business Backpack	2SC67AA
	·	
Docking	HP USB-C Mini Dock	1PM64AA
	HP Thunderbolt Dock 120W G2	2UK37AA
	HP TB Dock G2 w/ Combo Cable	3TR87AA
	HP TB Dock 120W G2 w/Audio	3YE87AA
	HP TB Dock 120W G2 Cable	3XB94AA
	HP TB Dock G2 Combo Cable	3XB96AA
	HP TB Dock G2 Audio Module	3AQ21AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP USB-C Dock G5	5TW10AA
Input / Output	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Bluetooth Travel Mouse	6SP30AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP HDMI to DVI Adapter	F5A28AA
	HP Elite USB-C Hub	4WX89AA
	HP USB-C Travel Hub G2	7PJ38AA
Power	HP 45W Smart AC Adapter 4.5mm	Н6Ү88АА
	65W Smart Power Adapter (w/ 4.5mm to 7.5mm DC dongle)	H6Y89AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 65W USB-C Slim Power Adapter	3PN48AA
	HP 65W USB-C Power Adapter	1HE08AA
	HP 45W USB-C Power Adapter	1HE07AA
	HP Power Bank	N9F71AA
	HP USB-C Power Bank	2NA10AA
Storage	HP External USB Optical Drive	F2B56AA
Security	HP Keyed Cable Lock 10mm	T1A62AA
	HP Sure Key Cable Lock	6UW42AA



Options and Accessories (sold separately and availability may vary by country)

Displays HP E223d Docking Monitor (Santino)

HP E243d Docking Monitor (Sonny)
HP E273d Docking Monitor (Vito)

HP EliteDisplay E244d Monitor (Sand Dollar)

HP EliteDisplay E274d Monitor (Glomar)

5VT82A8/5VT82AA

1TJ76AA

5WN63A8/5WN63AA

6PA50A8/6PA50AA

6PA56A8/6PA56AA



Summary of Changes

Date of change:	Version History:		Description of change:	
April 29, 2020	V1 to V2	Updated	MIL-STD 810G to MIL-STD 810H	
May 7, 2020	V2 to V3	Updated	Ethernet Section	
May 28, 2020	V3 to V4	Updated	Ports and Memory Section	
August 31, 2020	V4 to V5	Updated	Processor Section	
September 22, 2020	V5 to V6	Updated	Display Section	

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